

# SPECIFICATION

SPEC. No. \_\_\_\_\_

D A T E : 2013 Feb.

To \_\_\_\_\_

**Non-Controlled Copy**

CUSTOMER'S PRODUCT NAME

TDK'S PRODUCT NAME

WOUND/STD INDUCTOR,  
MAGNETIC SHIELDED  
LGJ10145TS-H SERIES HIGH RELIABILITY  
GRADE – See section 1 on page 1 for  
Important Product Information

**ALL ORDERS FOR THIS PRODUCT ARE SUBJECT TO THE TERMS AND CONDITIONS OF THIS SPECIFICATION**

DATE:                      YEAR                      MONTH                      DAY

TDK Corporation  
Sales  
Electronic Components  
Sales & Marketing Group

TDK-EPC Corporation  
Engineering  
Magnetics Business Group

| APPROVED | Person in Charge |
|----------|------------------|
|          |                  |

| APPROVED | CHECKED | Person in Charge |
|----------|---------|------------------|
|          |         |                  |

## 1. SCOPE AND MEANING OF “HIGH RELIABILITY GRADE”

This specification is applicable to WOUND STD INDUCTOR/MAGNETIC SHIELDED with a priority over the other relevant specifications. Manufacturing places defined in this specification shall be TDK-EPC Corporation Japan, and TDK Components USA. Inc.

“High Reliability Grade” means that TDK's LGJ Series Inductors provide an extended life Inductor that meets or exceeds the electrical, mechanical and environmental performance standards from AEC Q200 Rev.D. Details are referenced within section 7 of this specification. It also means that, in addition to our highest quality Inductor, the customer will also receive access to an on-line Sigma Report (Enhanced Certificate of Compliance) and internet based product authentication for each lot (which includes electrical characterization data, and estimated product life, as well as anti-counterfeit packaging). Additionally RFID (radio frequency identification) tags are available as an option.

### EXPLANATORY NOTE:

For warranty information, please refer to section 14 of this specification.

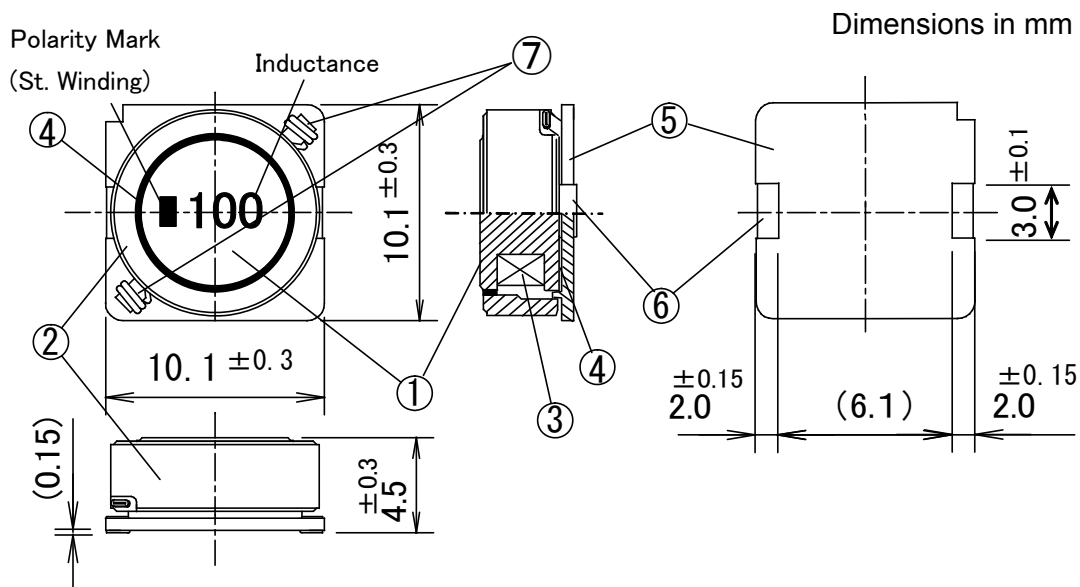
## 2. CODE CONSTRUCTION

(Example)

LGJ 10145 TS - 152 M R22 - H  
(1) (2) (3) (4) (5) (6) (7)

- (1) Series Name
- (2) Dimension L x W x T (10145: 10.1mm x 10.1mm x 4.5mm)
- (3) Packaging Style (TS: Tape & Reel)
- (4) Inductance Value (3R3 = 3.3 $\mu$ H; 100 = 10 $\mu$ H)
- (5) Inductance Tolerance (M:  $\pm$ 20%; N:  $\pm$ 30%)
- (6) Rated Current (2R5 = 2.5A; R90 = 0.90A)
- (7) Operating Temperature Range (H: -40° C to +125° C)

### 3. SHAPES AND DIMENSIONS/CIRCUIT DIAGRAM



| No. | ITEM NAME    | MATERIAL                          |
|-----|--------------|-----------------------------------|
| 1   | Drum core    | Ferrite                           |
| 2   | Ring core    | Ferrite                           |
| 3   | Winding wire | Polyurethane enameled copper wire |
| 4   | Glue         | Epoxy resin                       |
| 5   | Base         | Phenolic resin                    |
| 6   | Terminals    | Tin plated copper(t=0.15)         |
| 7   | Solder       | Lead free solder(Sn-2Cu)          |

Note: 1) It is acceptable even if adhesive is out of ring core, but it shouldn't be out of base.

Note: 2) Even if the adhesives of an upper surface application have the portion which has not been buried completely, they presuppose that it is possible.

Note: 3) Values in parentheses are referential.

### 4. CHARACTERISTICS

Temperature rise : 30° C TYP. (IDC2)

Operating Temperature Range : -40° C to +125° C (Including Self Temperature Rise)

Storage Temperature Range : -40° C to +125° C

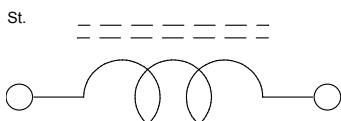
Rated current : Please see Section 5-1

Application

Reflow soldering can be used for this product while wave-flow can not be used.

The condition in soldering by hand should confirm to the heat capacitance corresponding to the test of resistance to soldering heat.

#### Equivalent Circuit



## 5. ELECTRICAL CHARACTERISTICS

### 5-1. Electrical Specifications

| Customer Part Number | TDK Item Description | Inductance L (μH) at 100kHz | DC resistance R <sub>DC</sub> (Ω) | *Rated Current (A)   |                          | Marking |
|----------------------|----------------------|-----------------------------|-----------------------------------|----------------------|--------------------------|---------|
|                      |                      |                             |                                   | I <sub>DC1</sub> MAX | I <sub>DC2</sub> TYPICAL |         |
|                      | LGJ10145TS-3R3N3R7-H | 3.3±30%                     | 16.1m±20%                         | 4.9                  | 3.7                      | ■ 3R3   |
|                      | LGJ10145TS-5R6M3R2-H | 5.6±20%                     | 22.0m±20%                         | 3.8                  | 3.2                      | ■ 5R6   |
|                      | LGJ10145TS-100M2R5-H | 10±20%                      | 36.4m±20%                         | 3.0                  | 2.5                      | ■ 100   |
|                      | LGJ10145TS-150M2R2-H | 15±20%                      | 47.2m±20%                         | 2.4                  | 2.2                      | ■ 150   |
|                      | LGJ10145TS-220M1R9-H | 22±20%                      | 59.1m±20%                         | 2.1                  | 1.9                      | ■ 220   |
|                      | LGJ10145TS-330M1R6-H | 33±20%                      | 81.5m±20%                         | 1.6                  | 1.7                      | ■ 330   |
|                      | LGJ10145TS-470M1R4-H | 47±20%                      | 0.10±20%                          | 1.4                  | 1.5                      | ■ 470   |
|                      | LGJ10145TS-680M1R2-H | 68±20%                      | 0.14±20%                          | 1.2                  | 1.3                      | ■ 680   |
|                      | LGJ10145TS-101M1R0-H | 100±20%                     | 0.20±20%                          | 1.0                  | 1.1                      | ■ 101   |
|                      | LGJ10145TS-151MR79-H | 150±20%                     | 0.35±20%                          | 0.79                 | 0.81                     | ■ 151   |
|                      | LGJ10145TS-221MR65-H | 220±20%                     | 0.47±20%                          | 0.65                 | 0.70                     | ■ 221   |
|                      | LGJ10145TS-331MR54-H | 330±20%                     | 0.68±20%                          | 0.54                 | 0.58                     | ■ 331   |
|                      | LGJ10145TS-471MR47-H | 470±20%                     | 1.03±20%                          | 0.47                 | 0.47                     | ■ 471   |
|                      | LGJ10145TS-681MR38-H | 680±20%                     | 1.6±20%                           | 0.38                 | 0.38                     | ■ 681   |
|                      | LGJ10145TS-102MR29-H | 1000±20%                    | 2.8±20%                           | 0.32                 | 0.29                     | ■ 102   |
|                      | LGJ10145TS-152MR22-H | 1500±20%                    | 3.4±20%                           | 0.22                 | 0.26                     | ■ 152   |

\*Rated current : the less value which is IDC1 or IDC2.

(Current is D.C. current)

IDC1 : Based on inductance change(ΔL:-10% MAX from initial L value.)

IDC2 : Based on temperature rise(ΔT:30°C TYP.)

#### Test Instruments

L : 4194A IMPEDANCE/GAIN-PHASE ANALYZER, HP OR EQUIV.

RDC : MILLIOHM METER VP-2941A MATUSITA OR EQUIV.

L(IDC1) : 4284A PRECISION LCR METER, HP with 42841A BIAS CURRENT SOURCE, HP / 42842A TEST FIXTURE, HP OR EQUIV.

## 6. STORAGE TERMS AND CONDITIONS

### 6-1. Storage condition before mounting:

5° C to 30° C at 20 to 75% RH Max

Use within 6 months from delivery date

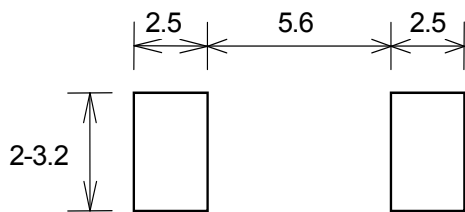
Solderability might be decreased if the period is exceeded.

## 7. PERFORMANCE

| No. | Item                                | Performance                                                        | Test Condition / Inspection Method                                                                          |
|-----|-------------------------------------|--------------------------------------------------------------------|-------------------------------------------------------------------------------------------------------------|
| 1   | High Temperature Exposure (Storage) | $\Delta L/L0 \leq \pm 5\%$<br>There shall be no mechanical damage. | MIL-STD-202 Method 108<br>125° C / 2000h                                                                    |
| 2   | Temperature Cycling                 | $\Delta L/L0 \leq \pm 5\%$<br>There shall be no mechanical damage. | JESD22 Method JA-104<br>-40/+125° C (Dwell 30min) / 2000cycles                                              |
| 3   | Biased Humidity                     | $\Delta L/L0 \leq \pm 5\%$<br>There shall be no mechanical damage. | MIL-STD-202 Method 103<br>85° C 85%R.H. / 2000h                                                             |
| 4   | Operational Life                    | $\Delta L/L0 \leq \pm 5\%$<br>There shall be no mechanical damage. | MIL-PRF-27<br>95° C / 2000h<br>Current rating is energized.                                                 |
| 5   | External Visual                     | No Visual Damage                                                   | MIL-STD-883 Method 2009                                                                                     |
| 6   | Physical Dimensions                 | Section 3. Shapes and Dimensions                                   | JESD22 Method JB-100<br>Length , Width , Height dimension                                                   |
| 7   | Resistance to Solvents              | No Visual Damage                                                   | MIL-STD-202 Method 215                                                                                      |
| 8   | Mechanical Shock                    | $\Delta L/L0 \leq \pm 5\%$<br>There shall be no mechanical damage. | MIL-STD-202 Method 213 Method 213<br>Peak:100G Half-sine / Duration:6ms /<br>Number of times:6axis x 3times |
| 9   | Vibration                           | $\Delta L/L0 \leq \pm 5\%$<br>There shall be no mechanical damage. | MIL-STD-202 Method 204<br>10-2000Hz / 5G or 1.52mmP-P /<br>20 min x 12 cycles x 3axis                       |
| 10  | Resistance to Soldering Heat        | $\Delta L/L0 \leq \pm 5\%$<br>There shall be no mechanical damage. | MIL-STD-202 Method 210<br>Test Type: Dip Solder: 260° C Dipping Time:10sec                                  |
| 11  | Solderability                       | Covered by New Solder over 95%.                                    | J-STD-002<br>Method B, 4hrs@235° C, category 3<br>J-STD-002<br>Method B, @215° C, category 3                |
| 12  | Electrical Characterization         | $\Delta L/L20^{\circ} \text{ C} \leq \pm 15\%$                     | Inductance change rate based on 20° C<br>(-40~125° C)                                                       |
| 13  | Board Flex                          | $\Delta L/L0 \leq \pm 5\%$<br>There shall be no mechanical damage. | AEC-Q200-005<br>2mm / 60sec                                                                                 |
| 14  | Terminal Strength (SMD)             | $\Delta L/L0 \leq \pm 5\%$<br>There shall be no mechanical damage. | AEC-Q200-006<br>17.7N / 60sec                                                                               |

## 8. RECOMMENDED FOOTPRINT

### 8-1. Land Pattern Dimension (ref)

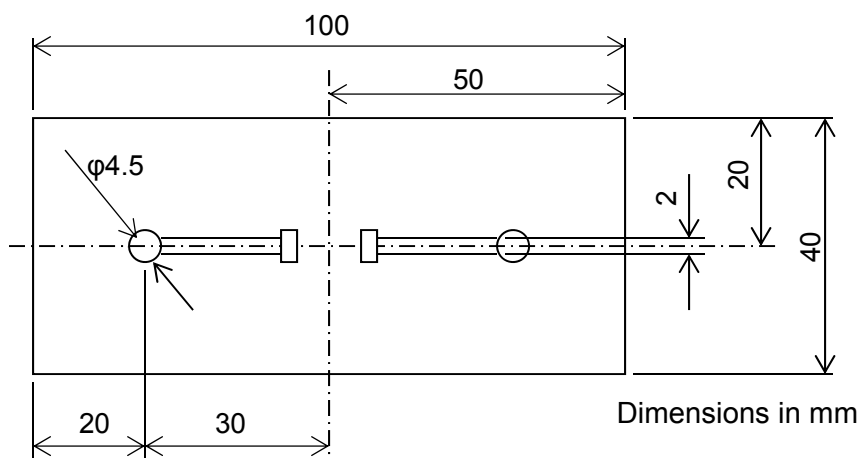


Adjacent land patterns and lines on the PCB should be covered with resist.

Dimensions in mm

### 8-2. Test PCB Dimension

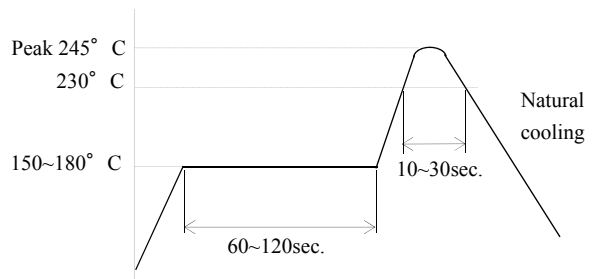
Substrate Bending Test Board  
Glass epoxy  $t = 1.6\text{mm}$



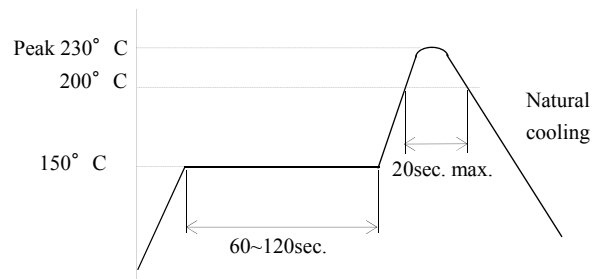
Dimensions in mm

## 9. RECOMMENDED SOLDERING PROFILE (REFLOW ONLY)

### 9-1. Profile for Pb-Free Solder



### 9-2. Profile for Sn-Pb Solder

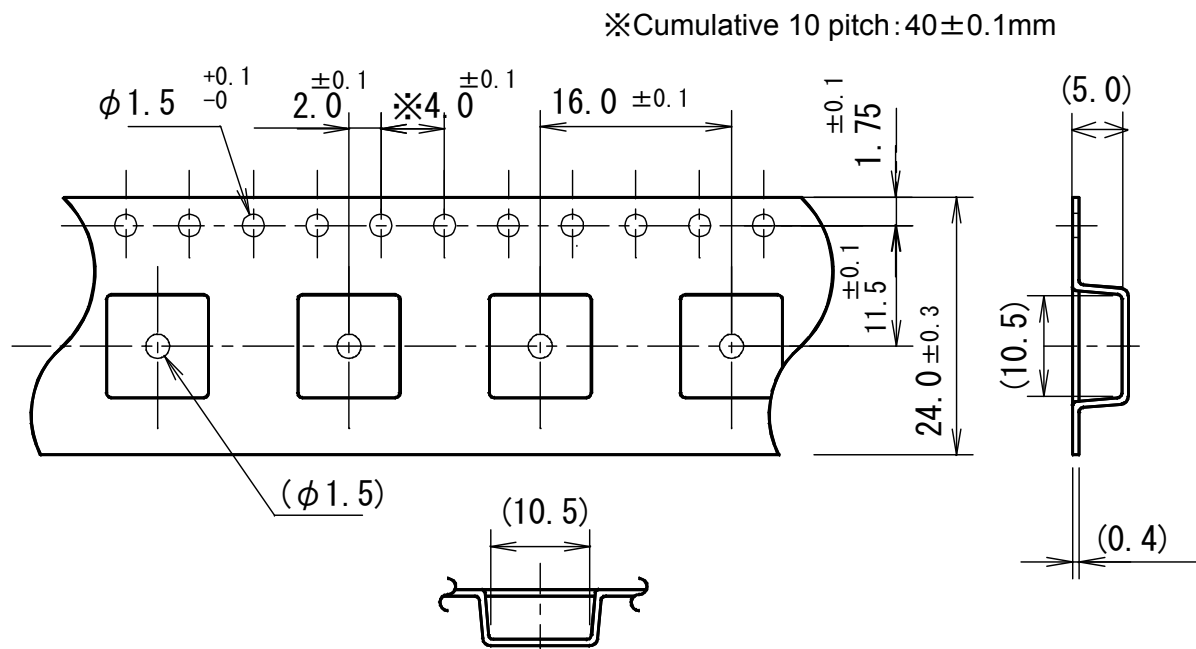


### 9-3. Iron Soldering

Use a solder iron of less than 30W. When soldering, do not allow the soldering iron tip to directly touch the ferrite body outside of the terminal electrode. 3 seconds max. at 350°C.

## 10. PACKAGING SPECIFICATION

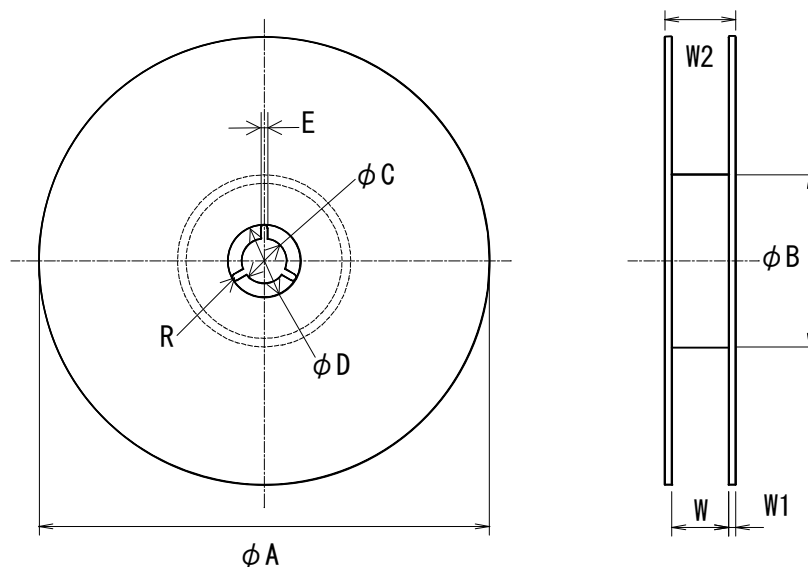
### 10-1. Dimensions of carrier tape



Packaging Format: EIAJ-RC-1009B

Dimensions in mm

### 10-2. Dimensions of carrier tape



Dimensions in mm

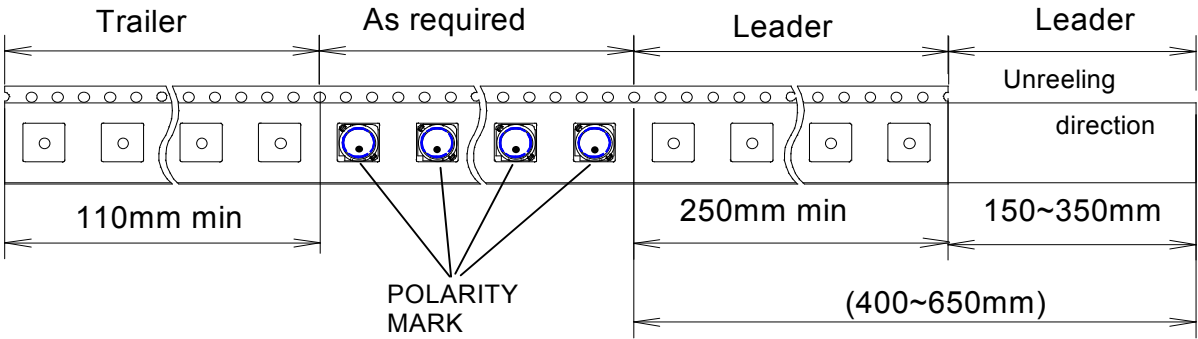
| $\phi A$    | $\phi B$   | $\phi C$       | $\phi D$       | $E$           | $W$          | $W1$          | $W2$         | $R$   |
|-------------|------------|----------------|----------------|---------------|--------------|---------------|--------------|-------|
| $330 \pm 2$ | 50 or more | $13.0 \pm 0.5$ | $21.0 \pm 0.8$ | $2.0 \pm 0.5$ | $24.4 +2/-0$ | $2.0 \pm 0.5$ | 30.4 or less | (1.0) |

### 10-3. Quantity: 500 pcs/Reel

### 10-4. The products are packaged so that no damage will be sustained.

10-5. Bulk part and leader of tape

(QUANTITY : 500PCS.)



## 11. PACKAGING LABEL

11-1. Packaging shall be done to protect the components from the damage during transportation and storing, and a label which has the following information shall be attached.

- 1) Inspection No.
- 2) TDK P/N
- 3) Customer's P/N
- 4) Quantity

\*Composition of Inspection No.

Example F 2 A – OO – OOO

(a) (b) (c) (d) (e)

- a) Line code
- b) Last digit of the year
- c) Month and A for January and B for February and so on. (Skip I)
- d) Inspection Date of the month.
- e) Serial No. of the day



### 11.2 Anti-counterfeit Label

The anti-counterfeit label with a unique identification code is placed over the reel flanges to ensure material authenticity.

Product authentication can be confirmed by visiting TDK.com and entering the requested information. The secure on-line system will provide an immediate response to the authenticity of the TDK product from the information provided.



DO NOT USE if the seal is broken or evidence of tampering is present.

Contact your local TDK representative for further instructions.

TDK's RFID reel tags are commissioned with lot specific information such as: lot number, customer part number, and quantity. RFID reel tag data can be customized to meet individual customer RFID requirements, as up to 64 bits of data can be stored on the RFID tag. Please contact your TDK sales representative for more information regarding customized information for RFID reel tags.

Below is an example of TDK standard RFID reel tag data (red font indicates data identifiers).

PLGJ10145TS-680M1R2-H, 1PLGJ10145TS-680M1R2-H, Q500  
(customer part no.) (TDK item description) (reel quantity)

TDK's RFID tag is compliant to ISO/IEC 18000-6 :2010 requirements and can be read within the standard operating frequency range for the United States (902-928Mhz) and international regulated frequencies within the Ultra High Frequency (UHF) bandwidth for Europe (865-868Mhz) and Japan (952-957Mhz).

## 12. SIGMA REPORT (ENHANCED CERTIFICATE OF COMPLIANCE)

The Sigma Report, an enhanced Certificate of Compliance will be performed for each lot. The results will be available on-line by visiting TDK.com and entering the requested information.

The Sigma Report will include performance (electrical and mechanical) and reliability metrics (FIT and MTTF).

A list of test completed is provided in Table 12.1.

Table 12.1

| Ref | Test          |
|-----|---------------|
| 1   | Appearance    |
| 2   | Dimensions    |
| 3   | Inductance    |
| 4   | DC Resistance |
| 5   | Solderability |

## 13. NOTE

13-1. If there occurs something to be discussed, it should be treated on deliberation between customer and TDK-EPC Corporation.

13-2. Please don't use the product that experienced falling.

However, If the falling is from less than 20cm high to vinyl-tile-like ground, The product with normal appearance and characteristics can be used.

13-3. Please don't apply the stress more 19.6N onto the top of the product.

13-4. If acoustic noise was occurred by magnetostrictive, it is preferable that reject or attenuate the audible frequency of current.

## 14. WARRANTY

TDK's LGJ Series Inductors are designed and warranted to meet the performance standards shown in Section 7 (Performance Table) of this specification using the test and inspection methods specified therein.

While LGJ Series Inductors are intended for high reliability applications within the range of conditions set forth in this specification, TDK is not aware of all applications in which these parts may be used, or the requirements of your particular application.

This series is not designed or warranted to meet any specifications of any intermediate or end user different from or in addition to those contained in this specification, nor are they intended or warranted for use in the Excluded Applications below.

Excluded Applications :

- Aerospace/aviation equipment (where the application is related to flight);
- FDA Class III medical equipment (and including any in-the-body medical application or any other medical application where failure of the TDK part could possibly endanger human life or health);
- Nuclear energy-related equipment; and/or
- Military equipment (where related to (i) destructive functionality including ammunition, firearms, warheads, mines and/or bombs, or (ii) discharging, emitting or blast-off functionality including artillery or missiles, or (iii) military aircraft or spacecraft).

Additionally, if you intend to use TDK's LGJ Series Inductors in any of the applications listed below ("Specialized Applications"), you should carefully review the requirements of the your particular application as against this specification so as to ensure the suitability of these parts for that application. TDK cannot ensure the suitability of these parts for the Specialized Applications below:

Specialized Applications :

- FDA Class I and II medical equipment (with the sale of parts for FDA Class II applications subject to prior TDK consultation).
- Transportation equipment (electric trains, ships, etc.)  
[other than automotive applications];
- Transportation control equipment;
- Power-generation control equipment;
- Seabed equipment;
- Public information processing equipment;
- Electric heating apparatus and/or burning equipment;
- Disaster/crime prevention equipment; and/or
- Safety equipment.

TDK MAKES NO OTHER WARRANTIES, EXPRESS OR IMPLIED, INCLUDING THE WARRANTIES OF MERCHANTABILITY AND/OR FITNESS FOR A PARTICULAR PURPOSE. IN NO EVENT SHALL TDK BE RESPONSIBLE FOR ANY DAMAGE OR LIABILITY CAUSED BY USE OF THESE PARTS IN ANY OF THE EXCLUDED APPLICATIONS LISTED ABOVE OR FOR ANY OTHER USE EXCEEDING THE RANGE OR CONDITIONS SET FORTH IN THIS SPECIFICATION.

Please note that when designing your product, device, or equipment-even for general purpose applications - you should secure a protection circuit/device or provide backup circuits in your product, device, or equipment.

## 15. CAUTIONS

Please read the instructions here before you use this product

### INSTRUCTIONS FOR USING THIS PRODUCT

#### STORAGE

- \* Store this product under the conditions which are defined in the catalogue or the instruction book. Confirm the soldering property before using if you have stored the product over the conditions which are defined in the catalogue or the instruction book.
- \* Do not use or store in locations where there are gas, corrosion (salt, acid alkaline, etc.)
- \* Avoid the direct rays of the sun and dew condensation.
- \* Do not expose the product to magnets or magnetic fields.

#### USING CONDITIONS

- \* Use this product under the conditions which are defined in the catalogue or the instruction book. Temperature range and soldering property are especially to be noticed.
- \* This product is designed for public welfare. If you are to use it for other purposes and if it is beyond the conditions in the instruction book, you should make a good examination beforehand.
- \* Don't use this product in locations:
  - Exposed to water or seawater.
  - With excessive moisture exposure.
  - Do not use this product in locations where there are gas corrosion (salt, acid, alkaline, etc.)
  - With vibrations and impulses which are not defined in the instruction book.
- \* When soldering is touched up after reflow to the PC Board, confirm the conditions which are defined in the catalogue or the instruction book.
- \* If it is heated excessively, the product may experience conditions such as short circuit, rough contact, lowering of characteristic and shortening of its life.
- \* Do good washing after soldering and make sure there is no residue left.
- \* Dry thoroughly after washing.
- \* Don't use the product if it is mechanically dropped.
- \* Pay attention to stresses to the product by bending of the PC Board.

Компания «Life Electronics» занимается поставками электронных компонентов импортного и отечественного производства от производителей и со складов крупных дистрибьюторов Европы, Америки и Азии.

С конца 2013 года компания активно расширяет линейку поставок компонентов по направлению коаксиальный кабель, кварцевые генераторы и конденсаторы (керамические, пленочные, электролитические), за счёт заключения дистрибьюторских договоров

Мы предлагаем:

- Конкурентоспособные цены и скидки постоянным клиентам.
- Специальные условия для постоянных клиентов.
- Подбор аналогов.
- Поставку компонентов в любых объемах, удовлетворяющих вашим потребностям.
- Приемлемые сроки поставки, возможна ускоренная поставка.
- Доставку товара в любую точку России и стран СНГ.
- Комплексную поставку.
- Работу по проектам и поставку образцов.
- Формирование склада под заказчика.
- Сертификаты соответствия на поставляемую продукцию (по желанию клиента).
- Тестирование поставляемой продукции.
- Поставку компонентов, требующих военную и космическую приемку.
- Входной контроль качества.
- Наличие сертификата ISO.

В составе нашей компании организован Конструкторский отдел, призванный помогать разработчикам, и инженерам.

Конструкторский отдел помогает осуществить:

- Регистрацию проекта у производителя компонентов.
- Техническую поддержку проекта.
- Защиту от снятия компонента с производства.
- Оценку стоимости проекта по компонентам.
- Изготовление тестовой платы монтаж и пусконаладочные работы.



Тел: +7 (812) 336 43 04 (многоканальный)

Email: [org@lifeelectronics.ru](mailto:org@lifeelectronics.ru)

[www.lifeelectronics.ru](http://www.lifeelectronics.ru)